| ASSOCIATION CONNECTIN                  | © Copyright 2005. IPC,<br>international and Pan-Ar | tion Dec<br>Bannockb<br>nerican co | <b>laration</b><br>urn, Illinois. A<br>pyright conver | ll rights reserved a | under both              | This docume<br>level parts, t                                     | ent is a declaration                      | tion of t<br>encomp | the substances<br>basses all lowe | within the<br>r level mate | manufactur<br>erials for wl     | er listed ite<br>hich the m  | em. Note:<br>anufacture | if the item is an as<br>er has engineering | sembly with low responsibility. |
|--|--|------------------------------------|---|----------------------|-------------------------|---|---|---------------------|-----------------------------------|----------------------------|---------------------------------|--|-------------------------|--|---------------------------------|
| 1752-21.1                              |  |                                    |   |                      | Form Type<br>Distribute | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Mater |   |                     |                                   |                            | als and Mfg Information         |  |                         |  |                                 |
| Supplier Inform                        | nation   |                                    |   |                      |                         |   |   |                     |                                   |                            |                                 |  |                         |  |                                 |
| Company name*                          |  |                                    | Company unique ID                                     |                      |                         | 1   | Unique ID Authority                       |                     |                                   |                            |                                 | Response Date*   |                         |  |                                 |
| In Semiconductor                       |  |                                    |   |                      |                         |   |   |                     |                                   |                            |                                 | 2021-02-03   |                         |  |                                 |
| Contact Name                           |  |                                    | Title - Contact                                       |                      |                         | ]   | Phone - Contact*                          |                     |                                   |                            | Email - Contact*                |  |                         |  |                                 |
| Product-Env-Stewards                   |  |                                    | Product Enviro Compliance                             |                      |                         |   | NA  |                     |                                   |                            | Product-Env-Stewards@onsemi.com |  |                         |  |                                 |
| Authorized Representative*             |  |                                    | Title - Representative                                |                      |                         | 1   | Phone - Representative*                   |                     |                                   |                            | Email - Representative*         |  |                         |  |                                 |
| Product-Env-Stewards                   |  |                                    | Product Enviro Compliance                             |                      |                         |   | NA  |                     |                                   |                            | Product-Env-Stewards@onsemi.com |  |                         |  |                                 |
| Requeste                               | Requester Item Number Mfr Item                     |                                    | Number Mfr Item Name                                  |                      |                         |   | Effective Date Version Manufacturing Site |                     |                                   | v                          | Veight*                         | UOM  | Unit Type               |  |                                 |
|  |  | BC557                              |   |                      |                         |   | 2021-02-03                                |                     |                                   |                            |                                 | 1  | 98.01                   | mg   | Each                            |
| lanufacturing                          | Proccess Information                               | n                                  |   |                      |                         |   |   |                     |                                   |                            |                                 | La construction de la constructi |                         |  |                                 |
| Terminal Plating / Grid Array Material |  | Cerminal Base Alloy J-STD-020      |   | J-STD-020 MS         | L Rating                | Peak Process Body Temperatur                                      |   | re Max Ti           | e Max Time at Peak Temper         |                            | ire Num                         | ber of Reflow Cyc  | les                     |  |                                 |
|  |  | C                                  | U Alloy   |                      |                         |   |   |                     | С                                 | 30                         |                                 | second   | ls 3                    |  |                                 |
| omments                                |  |                                    |   |                      |                         |   |   |                     |                                   |                            |                                 |  |                         |  |                                 |
|  |  |                                    |   |                      |                         |   |   |                     |                                   |                            |                                 |  |                         |  |                                 |
| or more informati                      | on regarding material con                          | position p                         | please refer to                                       | page 3               |                         |   |   |                     |                                   |                            |                                 |  |                         |  |                                 |

| RoHS Material Composition Declaration  |   |   |   | Declaration Type *   | Detailed  |
|--|---|---|---|--|---|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  |   | nium (Cr6+), Polybro  | minated Biphenyls (PBB), Polybron   | dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth  |   |
| cadmium, hexavalentchromium, polybromina<br>contains a RoHS restricted substance inexces<br>encompass all such components. Supplier cer<br>as of the date that Supplier completes this for<br>Company acknowledges that Supplier may h<br>independently verified information provided<br>certification in this paragraph. If the Company | ated biphenyls and/or polybrominated diples<br>of an applicable quantity limit, please in<br>iffies that it gathered the information it pro-<br>m.Supplier acknowledges that Company of<br>ave relied on informationprovided by othe<br>by others, Supplier agrees that, at a minim<br>v and the Supplier enter into a written agrees<br>source of the Supplier's liability and the O | nenyl ethers (each a "<br>dicate below which, i<br>ovides in this form usi<br>will rely on this certif<br>rs in completing this<br>um, itssuppliers have<br>ement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>f any, RoHS exemption you believe<br>ing appropriate methods to ensure it<br>ication in determining the complian<br>form, and that Supplier may not hav<br>provided certifications regarding th<br>the identified part, the terms and cc<br>for issues that arise regarding inform | ropean Union member states) of the part identifiess of the applicable quantity limit identified above may apply. If the part is an assembly with lowers accuracy and that such information is true and ce of its products with European Union member ve independently verified such information. How heir contributions to the part, and those certification on the Supplier provides in this form. In the | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>inty rights and/or remedies provided as part of |
| RoHS Declaration * 5 - Item(   | s) is obsolete, no information is available   |   |   | Supplier Acceptance *  | * Accepted  |
| Exemption: If the declared item does not of applicable exemptions.   | ontain RoHS restricted substances per   | the definition above  | except for defined RoHS exempti   | ons, then select the corresponding response in   | n the RoHS Declaration above and choose all   |
| Exemption List Version   | EL-2011/534/EU  |   |   |  |   |
| Declaration Signature  |   |   |   |  |   |
| Instructions: Complete all of the required<br>Requester) and click on Submit Form to h   |   |   | e Supplier Acceptance drop-down   | n. This will display the signature area. Digitall  | ly sign the declaration (if required by the   |
| Supplier Digital Signature   | astislav Drska  | 16  |   |  |   |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

|                      | cable [E] enter the weigh |                 |          | ance category (JIG or Requester) or enter a<br>[F] Optionally enter the positive (+) and no |                  |        |         |                 |
|----------------------|---------------------------|-----------------|----------|---|------------------|--------|---------|-----------------|
| Homogeneous Material | Weight                    | Unit of Measure | Level    | Substance   | CAS              | Exempt | Weight  | Unit of Measure |
| Die                  | 3.2                       | mg              | Supplier | Silicon (Si)  | 7440-21-3        |        | 3.2     | mg              |
| Lead Frame           | 85.82                     | mg              | Supplier | Silver (Ag)   | 7440-22-4        |        | 0.4291  | mg              |
|                      |                           |                 | Supplier | Copper (Cu)   | 7440-50-8        |        | 85.3909 | mg              |
| Mold Compound-Black  | 106.15                    | mg              |          | Brominated epoxy resin  | proprietary data |        | 0.5307  | mg              |
|                      |                           |                 | Supplier | Phenolic Resin  | Proprietary Data |        | 8.8105  | mg              |
|                      |                           |                 | В        | Antimony Trioxide (Sb2O3)   | 1309-64-4        |        | 1.2738  | mg              |
|                      |                           |                 | Supplier | Fused Silica (SiO2)   | 60676-86-0       |        | 77.9141 | mg              |
|                      |                           |                 | Supplier | Ortho Cresol Novolac Resin  | 29690-82-2       |        | 17.6209 | mg              |
| Plating              | 2.74                      | mg              | А        | Lead (Pb)   | 7439-92-1        |        | 0.548   | mg              |
|                      |                           | -               | Supplier | Tin (Sn)  | 7440-31-5        |        | 2.192   | mg              |
| Wire Bond - Au       | 0.1                       | mg              | Supplier | Gold (Au)   | 7440-57-5        |        | 0.1     | mg              |